

EREC2006CL

Hyperfast soft recovery rectifier



Product features

- Plastic package UL 94V-0
- Low reverse leakage current
- Hyperfast recovery time and soft recovery characteristics
- Low recovery loss

Mechanical data

- Case: TO-220C-2L molded plastic over passivated junction
- Terminals: Tin plated
- Weight: 2.0 gram typical

Package diagram/size and schematic



TO-220C-2L

Applications

- Switched mode power supplies (SMPS)
- Inverters
- Freewheeling diodes
- DC/DC converters
- Other power switching applications

Environmental compliance and general specifications



Ordering part number

E	R	E	C	20	06	CL
1	2	3	4	5	6	7

1	E=Eaton
2	R=Rectifier
3	E=Epitaxial process
4	C=Hyperfast
5	20= $I_F(AV)$: 20 A
6	06= V_{RRM} : 600 V
7	CL=Package: TO-220C-2L

Absolute maximum ratings

(Rating at +25 °C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	600	V
Maximum RMS voltage	V_{RMS}	420	V
Maximum DC blocking voltage	V_{DC}	600	V
Average forward current at $T_{mb} = 120\text{ °C}$	$I_{F(AV)}$	20	A
Peak forward surge current: 10 ms single half sinewave superimposed on rated load	I_{FSM}	200	A
Peak forward surge current: 8.3 ms single half sinewave superimposed on rated load		220	
Operating junction and storage temperature range	T_j, T_{stg}	-55 to +150	°C

Electrical characteristics

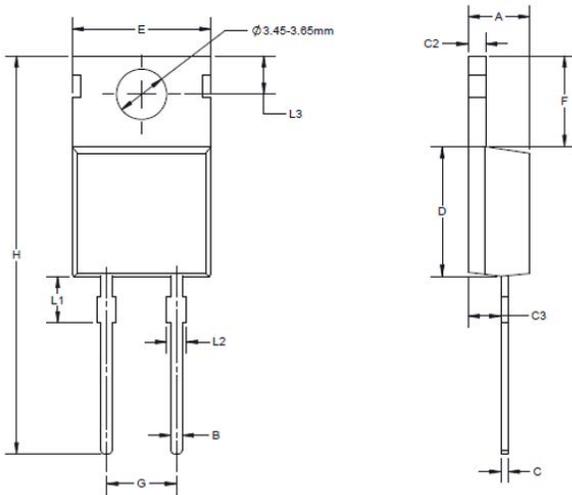
(Rating at +25 °C ambient temperature unless otherwise specified)

Parameter	Test condition	Symbol	Minimum	Typical	Maximum	Unit
Forward voltage @ $I_F=20\text{ A}$	$T_j=25\text{ °C}$	V_F	-	2	2.9	V
Reverse current at rated DC blocking voltage	$T_j=25\text{ °C}$	I_R	-	-	5	μA
	$T_j=150\text{ °C}$		-	-	300	
Reverse recovery time	$I_F=1\text{ A}, V_R=30\text{ V}, di/dt=200\text{ A}/\mu\text{s}, T_j=25\text{ °C}$	t_{rr}	-	16	20	ns
	$I_F=20\text{ A}, V_R=200\text{ V}, di/dt=200\text{ A}/\mu\text{s}, T_j=25\text{ °C}$		-	33	-	
	$I_F=20\text{ A}, V_R=200\text{ V}, di/dt=200\text{ A}/\mu\text{s}, T_j=125\text{ °C}$		-	51	-	
Peak reverse recovery current	$I_F=20\text{ A}, V_R=200\text{ V}, di/dt=200\text{ A}/\mu\text{s}, T_j=25\text{ °C}$	I_{RM}	-	2.8	-	A
	$I_F=20\text{ A}, V_R=200\text{ V}, di/dt=200\text{ A}/\mu\text{s}, T_j=125\text{ °C}$		-	7.6	-	
Reverse recovery charge	$I_F=20\text{ A}, V_R=200\text{ V}, di/dt=200\text{ A}/\mu\text{s}, T_j=25\text{ °C}$	Q_{rr}	-	47	-	nC
	$I_F=20\text{ A}, V_R=200\text{ V}, di/dt=200\text{ A}/\mu\text{s}, T_j=125\text{ °C}$		-	193	-	

Thermal resistances

Symbol	Parameter	Minimum	Typical	Maximum	Unit
$R_{th(j-a)}$	Thermal resistance from junction to ambient	-	60	-	°C/W
$R_{th(j-mb)}$	Thermal resistance from junction to mounting base	-	-	1.2	°C/W

Mechanical drawing- mm



Dimension	Minimum	Typical	Maximum
A	4.4	-	4.6
B	0.7	-	0.9
C	0.45	-	0.6
C2	1.23	-	1.32
C3	2.2	-	2.6
D	8.9	-	9.9
E	9.9	-	10.3
F	6.3	-	6.9
G	-	5.08	-
H	28	-	29.8
L1	-	3.39	-
L2	1.14	-	1.7
L3	2.65	-	2.95

Marking



Product information

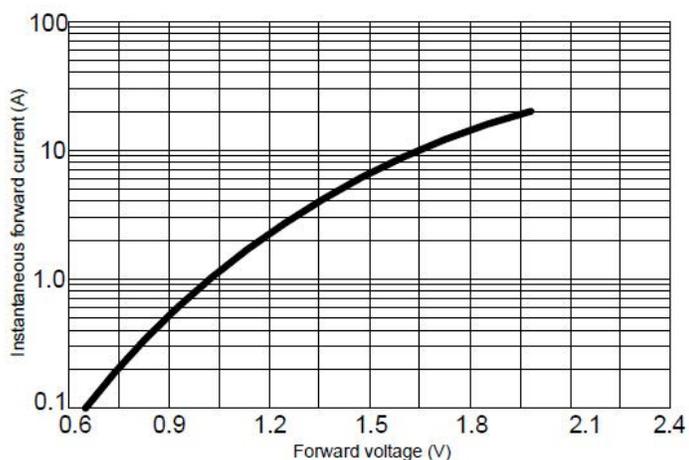
C	Hyperfast
20	$I_{F(AV)}$: 20 A
06	V_{RRM} : 600 V
CL	Package: TO-220C-2L
F35	Date code

Packaging information

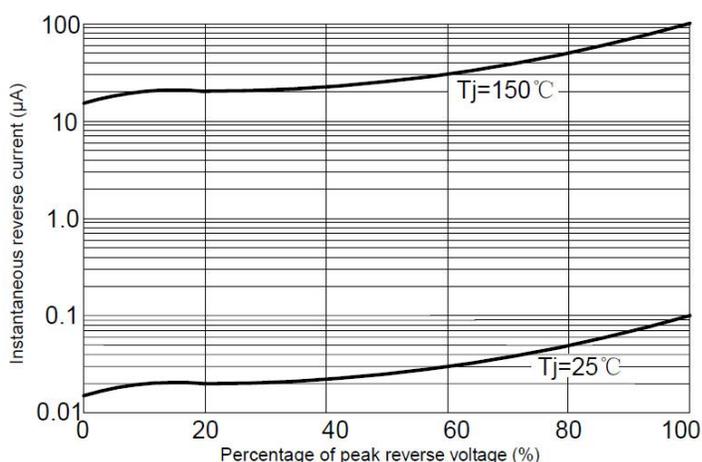
Outline	Unit weight (g/pcs) typical	Tube (pcs)	Per carton (pcs)
TUBE	2.0	50	5,000

Typical forward characteristics (+25 °C)

Typical forward characteristics (+25 °C)

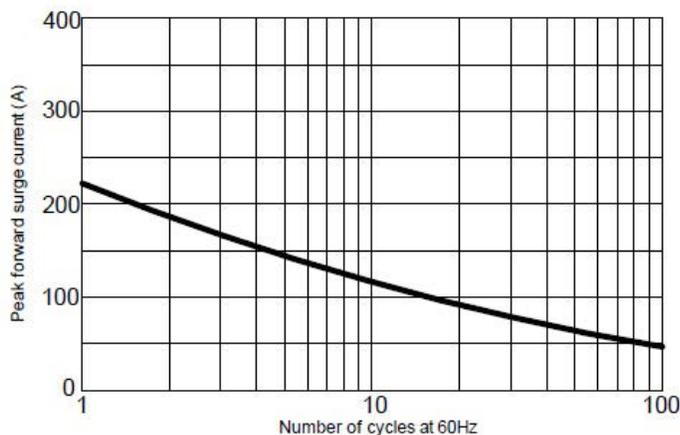
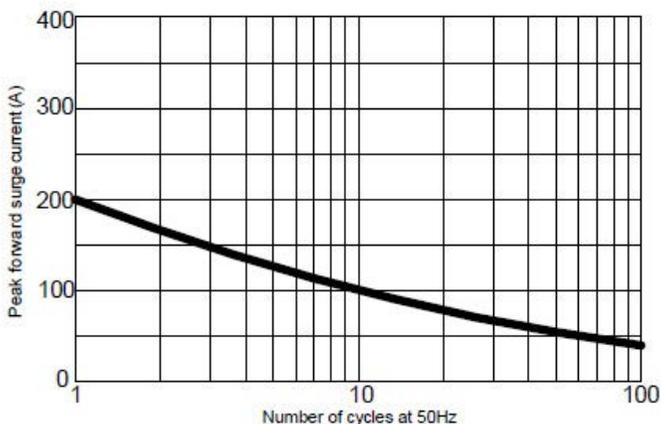


Typical reverse characteristics



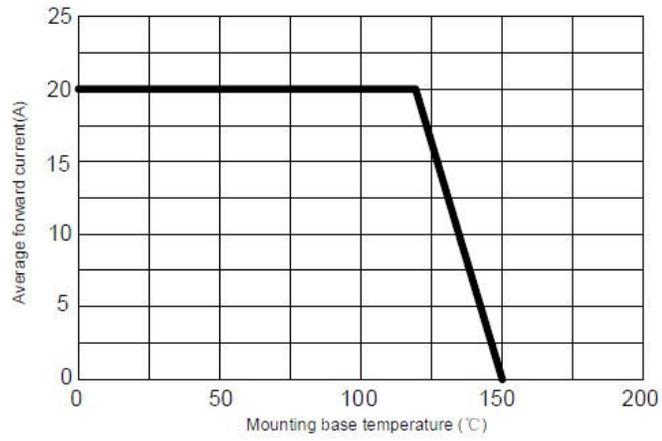
Maximum non-repetitive peak forward surge current (10 ms single half sine-wave) (+25 °C)

Maximum non-repetitive peak forward surge current (8.3 ms single half sine-wave) (+25 °C)

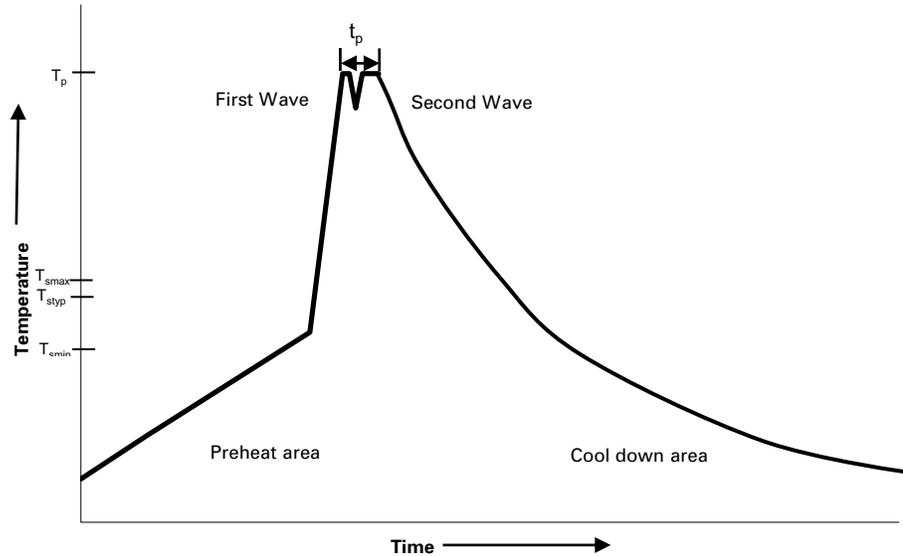


Typical characteristics

Forward current derating curve



Wave solder profile



Reference EN 61760-1:2006

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat		
• Temperature min. (T_{smin})	100 °C	100 °C
• Temperature typ. (T_{styp})	120 °C	120 °C
• Temperature max. (T_{smax})	130 °C	130 °C
• Time (T_{smin} to T_{smax}) (t_s)	70 seconds	70 seconds
Δ preheat to max Temperature	150 °C max.	150 °C max.
Peak temperature (T_p)*	235 °C – 260 °C	250 °C – 260 °C
Time at peak temperature (t_p)	10 seconds max 5 seconds max each wave	10 seconds max 5 seconds max each wave
Ramp-down rate	~ 2 K/s min ~3.5 K/s typ ~5 K/s max	~ 2 K/s min ~3.5 K/s typ ~5 K/s max
Time 25 °C to 25 °C	4 minutes	4 minutes

Manual solder

Use a 20 watt soldering iron with tip diameter of 1.0 mm maximum. +350 °C, 4-5 seconds maximum, generally manual, hand soldering is not recommended

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